



JAE Electronics, Inc.  
August 14<sup>th</sup>, 2018

## ENG-E18-166 – Distributors

### PCN (Process Change Notice) MX34003SF1 & MX34005SF1 Replacement Mold Die (J,K,L,M) To Keep Production Capacity

Part Number	2 Existing Mold Dies with 8 cavities	1 Replacement Mold Die with 4 cavities	Replacement Mold Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX34003SF1 MX34005SF1	(A,B,C,D), (E,F,G,H)	(J,K,L,M) To replace (A,B,C,D)	End of September 2018	End of October 2018	End of November 2018

Notes:

- PC = Process Change (in Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
- PPAP = Production Part Approval Process

1. PC PPAP will only be prepared and provided to customer who already requested and received Initial PPAP before.
2. If you request PPAP documents, please notify us ASAP.